

January 4, 2002

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Fr: George O. Saile     Reg. No. 19,572  
20 McIntosh Drive  
Poughkeepsie, N.Y. 12603

Subject:

**Divisional Patent Application of**  
Serial No.: 09/249,251 2/12/99

JOHN BRIAR

MOLDED STIFFENER FOR FLEXIBLE CIRCUIT  
MOLDING

**PRELIMINARY AMENDMENT**

Dear Sir:

This is a preliminary amendment for the above referenced Divisional Patent Application. Please amend the above identified application for patent as follows:

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on January 4, 2002.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date



**PLEASE AMEND THE SPECIFICATION AS FOLLOWS:**

After the title, insert -- This is a division of Patent Application serial number 09/249,251, filing date 2/12/99, Molded Stiffener For Flexible Circuit Molding, assigned to the same assignee as the present invention.

**REMARKS**

A reference to the parent case has been added by Preliminary Amendment to this Divisional Patent Application.

The application is believed to be in condition for allowance. Allowance of the subject Patent Application is therefore respectfully requested.

Respectfully submitted,

A handwritten signature in black ink, appearing to read 'S. B. Ackerman', with a stylized flourish at the end.

STEPHEN B. ACKERMAN, REG. NO. 37,761

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